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Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P_D	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	500	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	V_{RWM}	—	—	12	V	—
Channel Leakage Current (Note 6)	I_{RM}	—	1	100	nA	V_{RWM} = 12V
Clamping Voltage, IEC 61000-4-5	V_{CL}	—	—	20	V	I_{PP} = 1A, tp = 8/20μS
		—	—	25		I_{PP} = 4A, tp = 8/20μS
Breakdown Voltage	V_{BR}	13	—	—	V	I_R = 1mA
Channel Input Capacitance	C_T	—	20	26	pF	V_R = 0V, f = 1MHz

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
6. Short duration pulse test used to minimize self-heating effect.

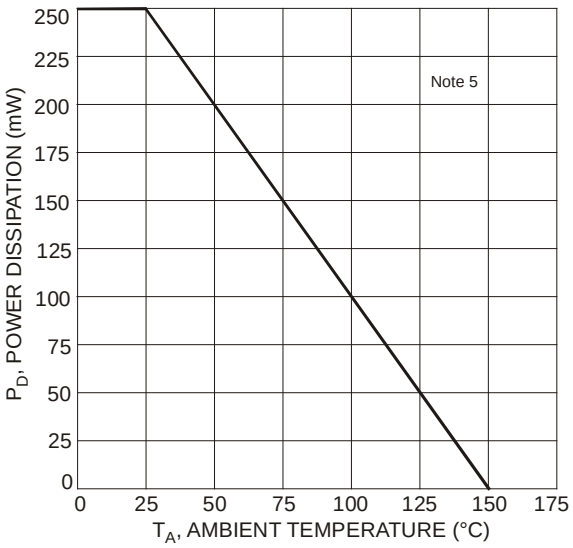

Figure 1 Power Derating Curve

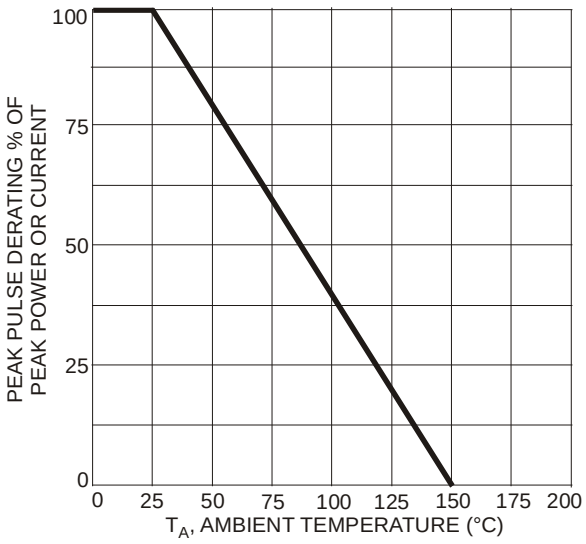

Figure 2 Pulse Derating Curve

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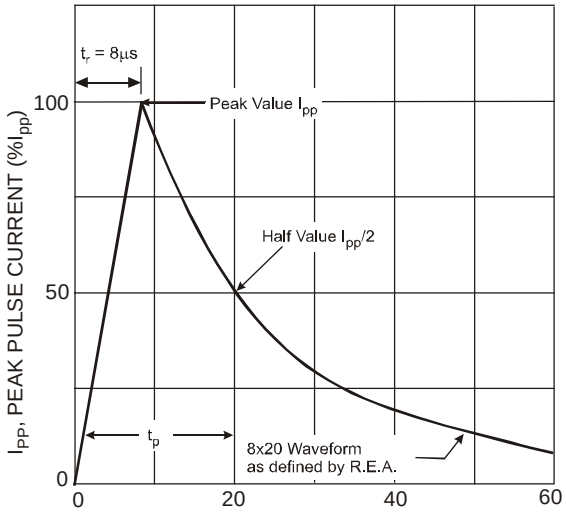

Figure 3 Pulse Waveform

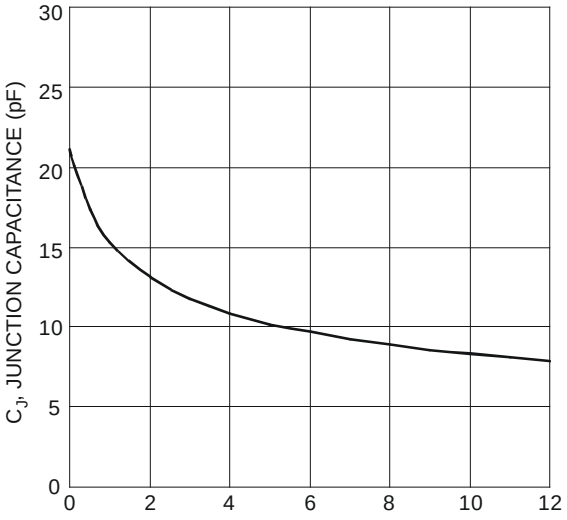

Figure 4 Typical Junction Capacitance

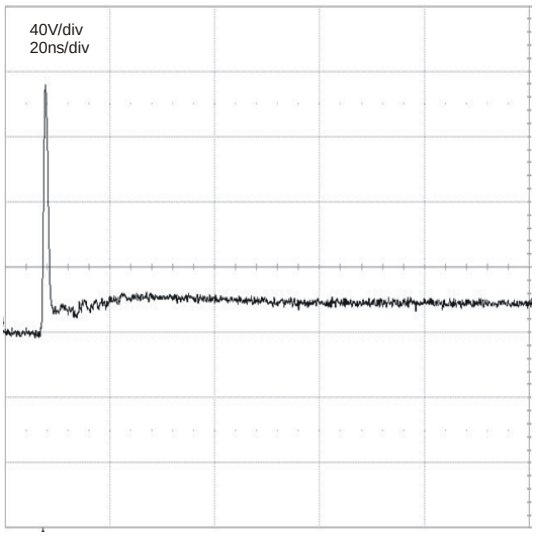

Figure 5 ESD Response to IEC 61000-4-2
(+8kV Contact Discharge)

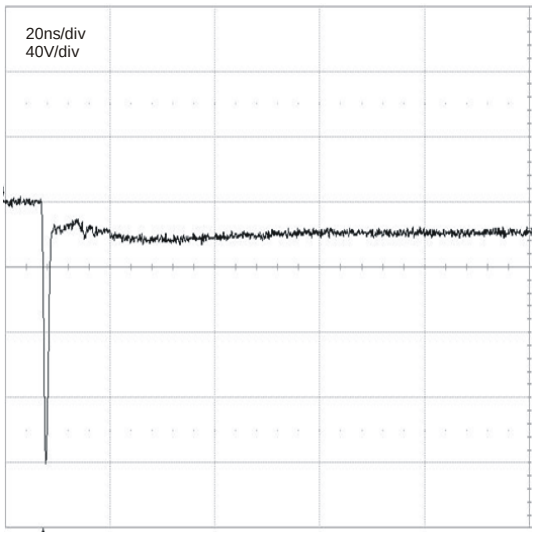

Figure 6 ESD Response to IEC 61000-4-2
(-8kV Contact Discharge)

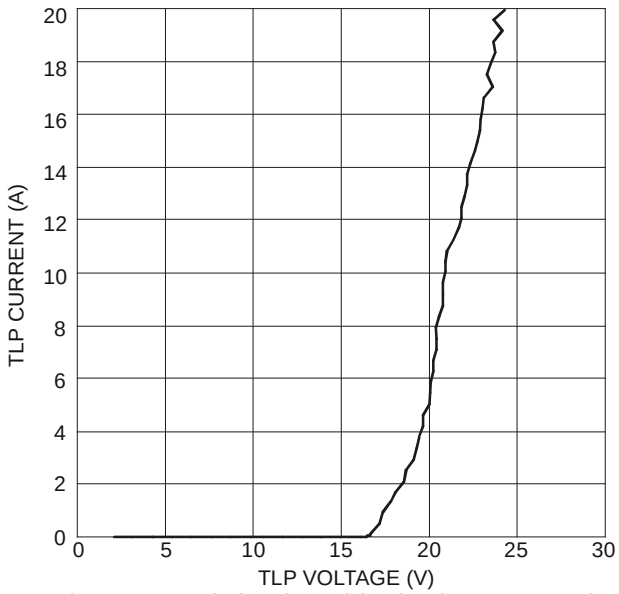

Figure 7 Transmission Line Pulsing (TLP) Current vs. Voltage

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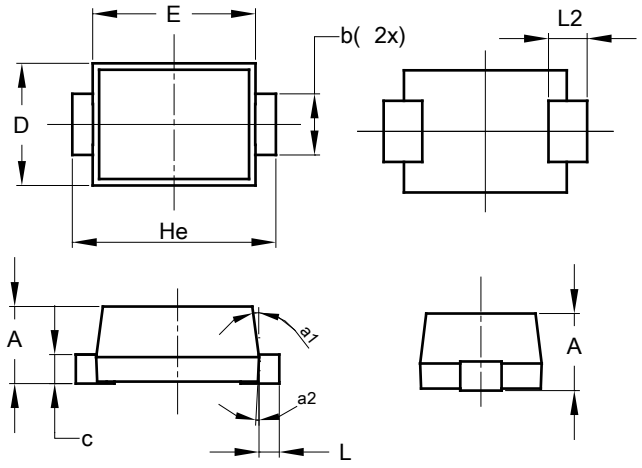
Package Outline Dimensions

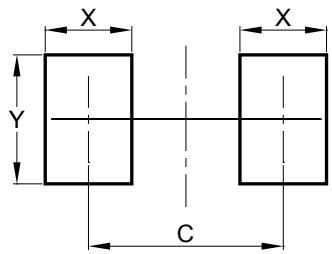
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOD923 (0.3mm Lead Width)			
Dim	**Min**	**Max**	**Typ**
A	0.34	0.40	0.37
b	0.25	0.35	0.30
c	0.05	0.15	0.10
D	0.55	0.65	0.60
E	0.75	0.85	0.80
He	0.95	1.05	1.00
L	0.05	0.15	0.10
L2	0.190 REF		
a1	0°	8°	7°
a2	2°	4°	3°
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
C	0.900
X	0.400
Y	0.600

NEW PRODUCT

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